

L Number	Hits	Search Text	DB	Time stamp
-	18	((("2585915") or ("3689346") or ("4191451") or ("4374077") or ("4414316") or ("4576850") or ("4582885") or ("4668558") or ("4810435") or ("4920038") or ("5175030") or ("5183597") or ("5260175") or ("5330799") or ("5468542") or ("5754332") or ("5815306") or ("5847327"))).PN.	USPAT	2003/01/08 15:51
-	24	WILLIAMS-Todd-R[in] BENSON-Olester[in]	USPAT; EPO; JPO; DERWENT	2002/12/28 14:05
-	1	((dimensional adj stability) (dimensionally adj stable)) same microstructure) and (metal near3 (film foil)) and (radiation near3 (cure curing curable cured))	USPAT; EPO; DERWENT	2002/12/28 14:09
-	151	((dimensional adj stability) (dimensionally adj stable)) and (metal near3 (film foil)) and (radiation near3 (cure curing curable cured))	USPAT; EPO; DERWENT	2002/12/28 14:55
-	1707	((427/510) or (427/553) or (427/557) or (427/595)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/07 11:32
-	977	((427/271) or (427/277) or (427/278)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:18
-	975	((427/355) or (427/359)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:18
-	1189	(427/384).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:19
-	4	((metal near3 (foil film)) and ((coat\$3 deposit\$3) same (radiation near3 (cure cured curing curable)) same (master stamper pattern\$3)) and ((cure cured curing) with (contact\$3))) and (((427/510) or (427/553) or (427/557) or (427/595)).CCLS.) ((427/271) or (427/277) or (427/278)).CCLS.) ((427/355) or (427/359)).CCLS.) ((427/384).CCLS.))	USPAT; EPO; DERWENT	2002/12/28 14:58
-	39	(metal near3 (foil film)) and ((coat\$3 deposit\$3) same (radiation near3 (cure cured curing curable)) same (master stamper pattern\$3)) and ((cure cured curing) with (contact\$3)))	USPAT; EPO; DERWENT	2002/12/28 15:24
-	4	((("5437754") or ("5378251") or ("5304223") or ("5152917"))).PN.	USPAT	2002/12/28 17:25
-	128	(metal near3 (film foil carrier)) and (coat\$3 same (radiation near3 (cure curing cured curable))) and ((pattern image microstructure) near10 (press impress contact)))	USPAT; EPO; DERWENT	2002/12/28 15:58
-	15	((metal near3 (film foil carrier)) and (coat\$3 same (radiation near3 (cure curing cured curable))) and ((pattern image microstructure) near10 (press impress contact))) and (427/\$[ccls])	USPAT; EPO; DERWENT	2002/12/28 16:07
-	113	((metal near3 (film foil carrier)) and (coat\$3 same (radiation near3 (cure curing cured curable))) and ((pattern image microstructure) near10 (press impress contact))) not ((metal near3 (film foil carrier)) and (coat\$3 same (radiation near3 (cure curing cured curable))) and ((pattern image microstructure) near10 (press impress contact))) and (427/\$[ccls]))	USPAT; EPO; DERWENT	2002/12/28 16:07

WPF 07/07/03

-	0	((metal with foil with backing) same (radiation with transmi\$5)) and ((master stamper roll roller) same (cure cured curing curable))	USPAT; EPO; DERWENT	2002/12/28 17:28
-	0	((metal with foil with backing) same (radiation with transmi\$5))	USPAT; EPO; DERWENT	2002/12/28 17:28
-	47	coating same (metal near3 foil) same (radiation with (cure curable curing cured))	USPAT; EPO; DERWENT	2002/12/28 17:29
-	18	(coating same (metal near3 foil) same (radiation with (cure curable curing cured))) and (pattern master stamper stamp)	USPAT; EPO; DERWENT	2002/12/28 17:35
-	1	("4773920").PN.	USPAT	2002/12/28 18:14
-	6	(radiation near3 (cure cured curing curable)) same (through with (metal near3 foil))	USPAT; EPO; DERWENT	2002/12/28 18:18
-	0	(radiation near3 (cure cured curing curable)) same (through with (metal near3 foil))	USOCR	2002/12/28 18:19
-	1	4566927[pn] and foil	USPAT	2002/12/28 18:37
-	1	4566927[pn] and foil and (aluminum "Al")	USPAT	2002/12/28 18:46
-	212	((cure curing cured) with through with foil)	USPAT	2002/12/28 18:47
-	25	((cure curing cured) with through with foil) same radiation	USPAT	2002/12/28 19:12
-	25	(Minnesota with Mining with Manufacturing)[as] and (metal with foil with backing) and (radiation with (cure cured curing))	USPAT	2002/12/28 19:19
-	19	polyolefin same (transparent transmissive) same (eb "e.b." "electron beam" e\$1beam)	USPAT	2002/12/28 19:20
-	51	((metal metallic metallized) near3 (foil film backing)) and (radiation near3 (cure curing cured curable)) and ((irradiating irradiation) with "through" with (foil film backing))	USPAT; EPO; DERWENT	2002/12/31 12:50
-	24	((metal near3 foil) with (substrate support backing)) and ((master stamper) same (cure cured curing))	USPAT; EPO; DERWENT	2002/12/31 13:13
-	0	((cure cured curing) with "in contact" with (master stamper)) and ((metal near3 foil) same (substrate support backing))	USPAT; EPO; DERWENT	2002/12/31 13:21
-	1	((cure cured curing) with (contact pressed pressing) with (master stamper)) and ((metal near3 foil) same (substrate support backing))	USPAT; EPO; DERWENT	2002/12/31 13:23
-	5	((("3882207") or ("4250209") or ("4601861") or ("4933120") or ("5155604"))).PN.	USPAT	2003/01/06 11:41
-	13	((metal adj foil) with (support substrate backing)) same (transparent transmissive) same ((electron adj beam) e\$1beam "EB" ultra\$lviolet "UV")	USPAT; EPO; JPO; DERWENT	2003/01/06 11:49
-	22594	(copper adj foil) "COPPERBOND"	USPAT; EPO; JPO; DERWENT	2003/01/06 11:50
-	0	COPPERBOND	USPAT; EPO; JPO; DERWENT	2003/01/06 11:50
-	211	(copper adj foil) with ((electron adj beam) e\$1beam "EB" ultra\$lviolet "UV")	USPAT; EPO; JPO; DERWENT	2003/01/06 11:51
-	86	((copper adj foil) with ((electron adj beam) e\$1beam "EB" ultra\$lviolet "UV")) same (master pattern stamper)	USPAT; EPO; JPO; DERWENT	2003/01/06 12:01
-	22	((metal adj foil) with (substrate support backing)) same (master pattern stamper) same ((thermal thermally heat heated heating) with (cure cured curing))	USPAT; EPO; JPO; DERWENT	2003/01/06 12:12

-	12	((metal adj foil) with (substrate support backing)) same (master pattern stamper) same ((thermal thermally heat heated heating) with (cure cured curing))	USOCR	2003/01/06 12:46
-	5185	((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 12:46
-	510	(427/370).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 12:46
-	8	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating)) and (((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.) ((427/370).CCLS.)	USPAT; EPO; JPO; DERWENT	2003/01/06 12:52
-	0	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (pattern stamper master)) and ((427/370).CCLS.)	USPAT; EPO; JPO; DERWENT	2003/01/06 12:54
-	0	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (pattern stamper master)) and (((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.)	USPAT; EPO; JPO; DERWENT	2003/01/06 12:54
-	344	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (pattern stamper master))	USPAT; EPO; JPO; DERWENT	2003/01/06 12:56
-	300	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (pattern stamper master))	USPAT	2003/01/06 13:07
-	19	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (stamper master))	USPAT	2003/01/06 13:59
-	4	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (stamper master))	USOCR	2003/01/06 13:58
-	0	(foil with (backing substrate support)) and ((cure cured curing) with (thermal thermally heat heated heating) same (stamper master))	EPO; DERWENT	2003/01/06 13:59
-	5	(foil with (backing substrate support)) and (((hot heat heated heating) with (emboss\$3 calender\$3)) same (cure cured curing thremosetting))	EPO; DERWENT	2003/01/06 14:00
-	32	(foil with (backing substrate support)) and (((hot heat heated heating) with (emboss\$3 calender\$3)) same (cure cured curing thremosetting))	USPAT; EPO; DERWENT	2003/01/06 14:04
-	6	("4600628" "4664965" "5098788" "5580610" "5633317" "5827788").PN.	USPAT	2003/01/06 14:16
-	1712	((427/510) or (427/553) or (427/557) or (427/595)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:18
-	977	((427/271) or (427/277) or (427/278)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:18
-	975	((427/355) or (427/359)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:19
-	1190	(427/384).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/06 14:19

-	10308	((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.) ((427/370).CCLS.) ((427/510) or (427/553) or (427/557) or (427/595)).CCLS.) ((427/271) or (427/277) or (427/278)).CCLS.) ((427/355) or (427/359)).CCLS.) ((427/384).CCLS.)	USPAT; EPO; JPO; DERWENT	2003/01/06 14:19
-	55	((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.) ((427/370).CCLS.) ((427/510) or (427/553) or (427/557) or (427/595)).CCLS.) ((427/271) or (427/277) or (427/278)).CCLS.) ((427/355) or (427/359)).CCLS.) ((427/384).CCLS.) and ((metal\$5 adj foil) with (substrate support backing))	USPAT; EPO; JPO; DERWENT	2003/01/06 14:25
-	38	((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.) ((427/370).CCLS.) ((427/510) or (427/553) or (427/557) or (427/595)).CCLS.) ((427/271) or (427/277) or (427/278)).CCLS.) ((427/355) or (427/359)).CCLS.) ((427/384).CCLS.) and ((metal\$5 adj foil) with (substrate support backing))) and ((heat heated heating thermoset thermosetting) with (resin coat\$3 polymer polymeric)))	USPAT; EPO; JPO; DERWENT	2003/01/06 14:27
-	24	((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.) ((427/370).CCLS.) ((427/510) or (427/553) or (427/557) or (427/595)).CCLS.) ((427/271) or (427/277) or (427/278)).CCLS.) ((427/355) or (427/359)).CCLS.) ((427/384).CCLS.) and ((metal\$5 adj foil) with (substrate support backing))) and ((heat heated heating thermoset thermosetting) with (resin coat\$3 polymer polymeric))) and (pattern\$3 emboss\$3 calender\$3)	USPAT; EPO; JPO; DERWENT	2003/01/06 14:28
-	24	((264/280) or (264/284) or (264/293) or (264/299) or (264/319)).CCLS.) ((427/370).CCLS.) ((427/510) or (427/553) or (427/557) or (427/595)).CCLS.) ((427/271) or (427/277) or (427/278)).CCLS.) ((427/355) or (427/359)).CCLS.) ((427/384).CCLS.) and ((metal\$5 adj foil) with (substrate support backing))) and ((heat heated heating thermoset thermosetting) with (resin coat\$3 polymer polymeric))) and (pattern\$3 emboss\$3 calender\$3 master stamper)	USPAT; EPO; JPO; DERWENT	2003/01/06 14:29
-	294	((heat heated heating hot) near3 (pressure press pressed pressing)) with (cure cured curing)) same (pattern patterned patterning master stamper)) and (foil backing substrate support) and (resin polymer polymeric)	USPAT	2003/01/07 10:44
-	74	((heat heated heating hot) near3 (pressure press pressed pressing)) with (cure cured curing)) same (pattern patterned patterning master stamper)) and (foil backing substrate support) and (resin polymer polymeric)) and ((metal metallic) adj (foil substrate backing))	USPAT	2003/01/08 10:56
-	11	("1548910" "2278291" "2606855" "3018206" "3303081" "3311520" "3373068" "3616011" "3718496" "3793125" "3802947").PN.	USPAT	2003/01/07 10:55
-	9	3997696.URPN.	USPAT	2003/01/07 10:55

-	5547	((427/510) or (427/553) or (427/557) or (427/595) or (427/271) or (427/277) or (427/278) or (427/355) or (427/359) or (427/384) or (264/284) or (264/293) or (427/370)).CCLS.	USPAT	2003/01/07 13:21
-	11	((427/510) or (427/553) or (427/557) or (427/595) or (427/271) or (427/277) or (427/278) or (427/355) or (427/359) or (427/384) or (264/284) or (264/293) or (427/370)).CCLS.) and ((cure cured curing thermoset\$4) with contact with (master stamper roller))	USPAT; EPO; JPO; DERWENT	2003/01/08 10:57
-	44	(hologram holographic) and ((substrate backing support) with foil with (aluminum "Al"))	USPAT; EPO; JPO; DERWENT	2003/01/08 10:56
-	794	((430/50) or (430/97) or (430/939)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/01/08 10:56
-	0	(((((heat heated heating hot) near3 (pressure press pressed pressing)) with (cure cured curing)) same (pattern patterned patterning master stamper)) and (foil backing substrate support) and (resin polymer polymeric)) and ((metal metallic) adj (foil substrate backing)) and ((430/50) or (430/97) or (430/939)).CCLS.)	USPAT	2003/01/08 10:58
-	10	((427/510) or (427/553) or (427/557) or (427/595) or (427/271) or (427/277) or (427/278) or (427/355) or (427/359) or (427/384) or (264/284) or (264/293) or (427/370)).CCLS.) and ((430/50) or (430/97) or (430/939)).CCLS.)	USPAT; EPO; JPO; DERWENT	2003/01/08 10:58
-	268	((aluminum "Al" copper "Cu" zinc "Zn" titanium "Ti" tin "Sn" iron "Fe" nickel "Ni" gold "Au" silver "Ag") adj foil) with (backing support substrate)) and (radiation with (cure cured curing))	USPAT	2003/01/08 15:55
-	129	((aluminum "Al" copper "Cu" zinc "Zn" titanium "Ti" tin "Sn" iron "Fe" nickel "Ni" gold "Au" silver "Ag") adj foil) with (backing support substrate)) and (radiation with (cure cured curing))) and (pattern master stamper decorative decoration)	USPAT	2003/01/09 10:56
-	2	("9015673").PN.	USPAT; EPO; JPO; DERWENT	2003/01/09 10:56
-	5259	((427/271) or (427/277) or (427/278) or (427/355) or (427/359) or (427/370) or (427/384) or (427/510) or (427/553) or (427/557) or (427/595)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/07/07 12:23
-	1730	((264/284) or (264/293)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/07/07 12:23
-	797	((430/50) or (430/97) or (430/939)).CCLS.	USPAT; EPO; JPO; DERWENT	2003/07/07 12:24
-	0	"large-scale predictable dimensional stability"	USPAT; EPO; JPO; DERWENT	2003/07/07 12:25
-	2	"large scale predictable dimensional stability"	USPAT; EPO; JPO; DERWENT	2003/07/07 12:26
-	0	"precisely shaped and located functional discontinuities"	USPAT; EPO; JPO; DERWENT	2003/07/07 12:27
-	0	"precisely shaped interactive functional discontinuities"	USPAT; EPO; JPO; DERWENT	2003/07/07 12:27

-	1	backing same master same (irradiate irradiation) same "through"	USPAT; EPO; JPO; DERWENT	2003/07/07 12:28
-	0	backing same master same (irradiate irradiation) same (cure cured curing cross\$1link\$3)	USPAT; EPO; JPO; DERWENT	2003/07/07 12:28